
APPLICATION DATA SHEET FORM

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Application Information

Title Line One:: Modular Substrate Gas Panel Having Manifold
Title Line Two:: Connections In A Common Plane
Total Drawing Sheets:: 15 pp.
Formal Drawings?: No
Claims:: 88
Application Type:: Utility

Application Data Sheet Form

Docket Number:: C1138-700110
Licensed US Govt. Agency::
Contract or Grant Numbers One::
Contract or Grant Numbers Two::
Secrecy Order in Patent Appl.?::

Representative Information

Representative Customer Number:: 37462

Continuity Information

This application claims the benefit under 35 U.S.C. §119(e) of:

>Application One:: 60/406,132
Filing Date:: August 27, 2002

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NOTE: *If there is more than one assignee, this information should be repeated for each one.*

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